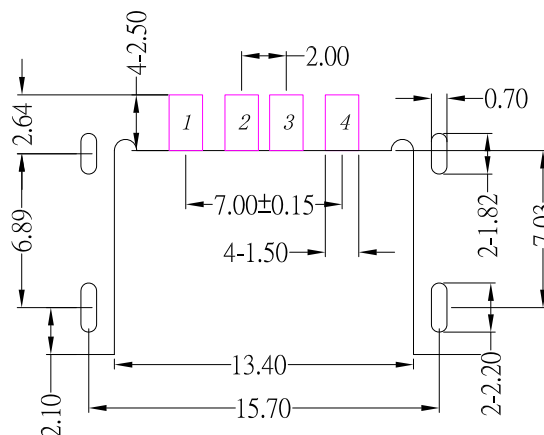
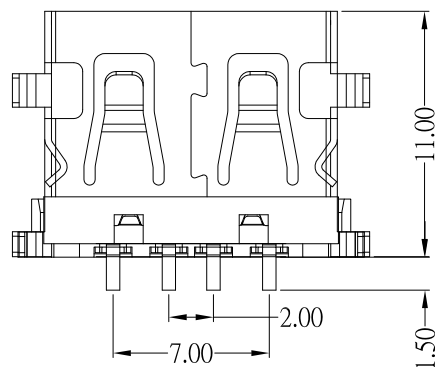
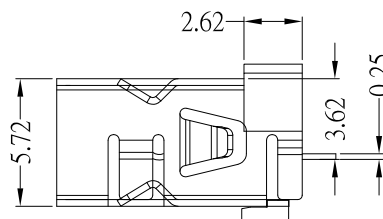




White : W
Black : B



RECOMMENDED PCB LAYOUT



- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

					 建倚科技股份有限公司 CONTACT TECHNOLOGY CORP. TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2 Above 5 ~ 15 ±0.3 Above 15 ~ 30 ±0.4 Above 30 ~ 50 ±0.5 Angle ±0.3° 3RD. ANGEL'S  UNITS MM	DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR			
						Jack Lu	06/17/20			FINISH		MODLE	USB AF SMT 沉板正向 H3.60mm無捲邊	
						CHECKED BY:	DATE			SCALE	1 : 1	DWG NO.	SUA-110E28-x-S236	SIZE
						Jacky Chen	06/17/20							A4
						APPROVED BY:	DATE			SHEET NO.	1 of 1	PART NO.	SUA-110E28-x-S236	VER
					Tony Kao	06/17/20							R	
ITEM NO.	DESCRIPTION			DRAWN	DATE									
	A		B			C	D		E	F	G	H	I	J